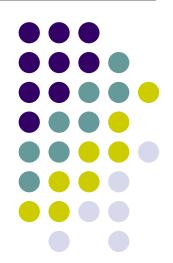
#### **SEMICON Solutions**

# Principles of ASIC Design

Trình bày: Đặng Tường Dương





#### **Agenda**

- Design Flow of ASICs
- ASICs & FPGAs
- CMOS Logic
- Design Specification
- RTL Coding
- Simulation
- Synthesis
- Floorplanning
- Placement
- Routing



#### **Agenda**



- Types of Design Styles
- ASIC & FPGA design flow
- Select ASIC or FPGA ???



#### What is ASIC?



- ASIC (application-specific integrated circuit)
- ASIC is an <u>IC</u> designed for a specific application.
- ASIC is applied for microprocessor of Mobile phone, microprocessor of automatic machines, media, automobile, ...



### Types of ASICs

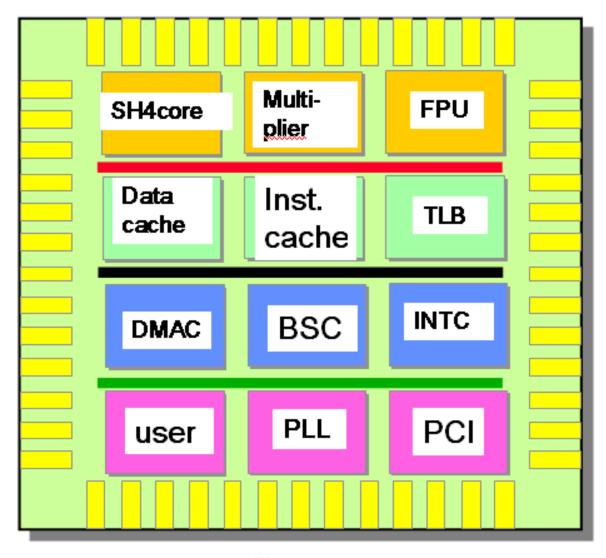


- Different types of ASICs are:
  - Full-custom ASICs
  - Semi-custom ASICs
    - Standard-cell-based ASICs (CBIC)
    - Gate-array—based ASICs
- Programmable ASICs
  - Programmable Logic Devices (PLD)
  - Field Programmable Gate Array (FPGA)



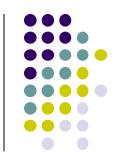
#### **ASIC** Architecture

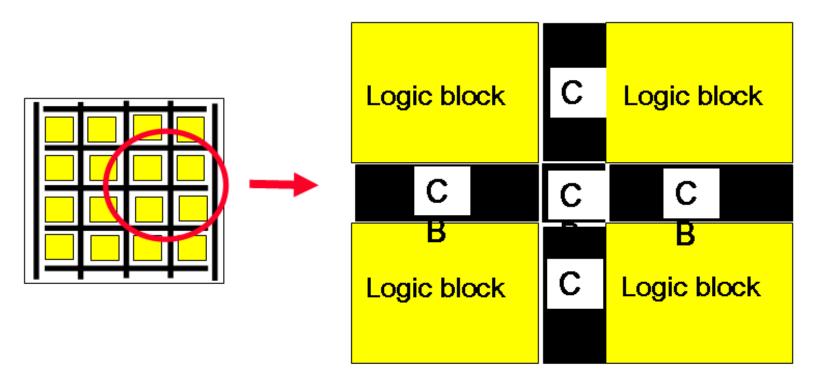






#### **FPGA Architecture**





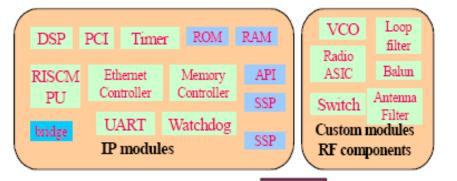
**CB:Connection Block** 

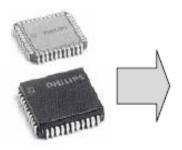
FPGA: Field Programmable Gate Array

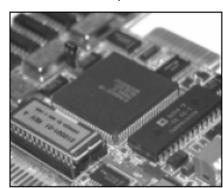


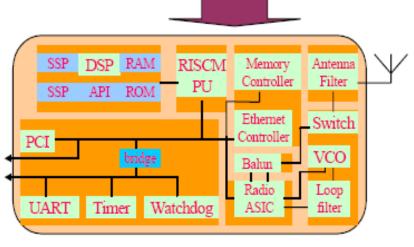
# An example of ASIC/FPGA Design

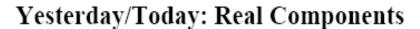




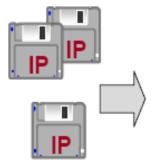


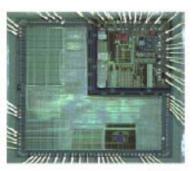






IP: Intellectual Property





Bluetooth 8



Today/Future: Virtual Components



## ASIC Design Flow

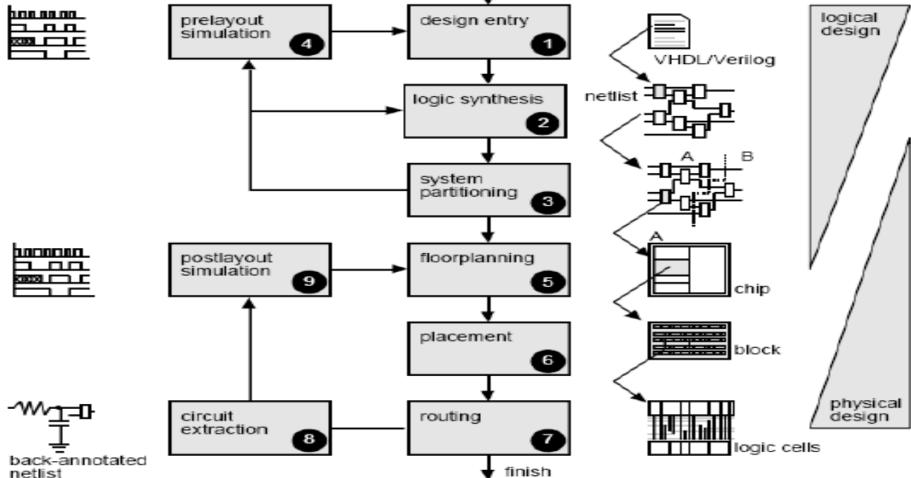


- A design flow is a sequence of steps to design an ASIC
  - Design entry: Using a hardware description language (HDL) or schematic entry.
  - Logic synthesis: Produces a netlist-logic cells and their connections.
  - System partitioning: Divide a large system into ASIC-sized pieces.
  - Prelayout simulation: Check to see if the design functions correctly.
  - Floorplanning: Arrange the blocks of the netlist on the chip.
  - Placement: Decide the locations of cells in a block.
  - Routing: Make the connections between cells and blocks.
  - Extraction: Determine the resistance and capacitance of the interconnect.
  - Postlayout simulation: Check to see the design still works with the added loads of the interconnect.



### ASIC Design Flow

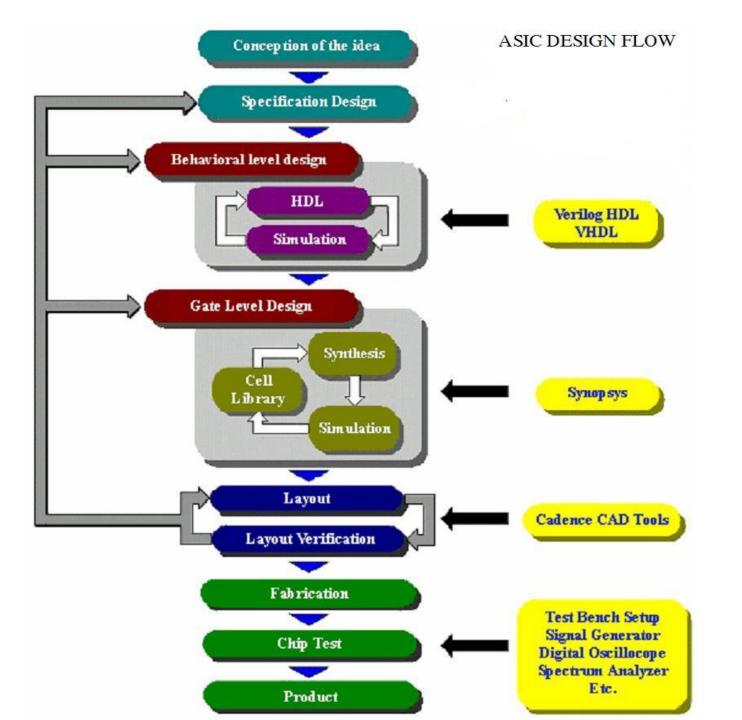


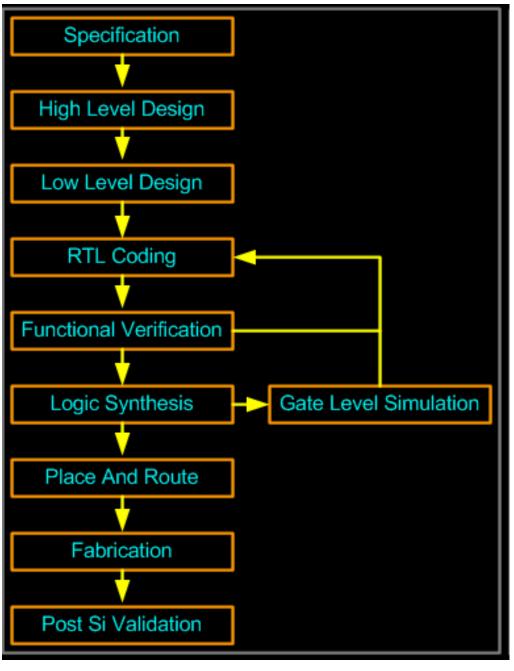


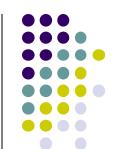
1-4: Logic Design

5-9: Physical Design

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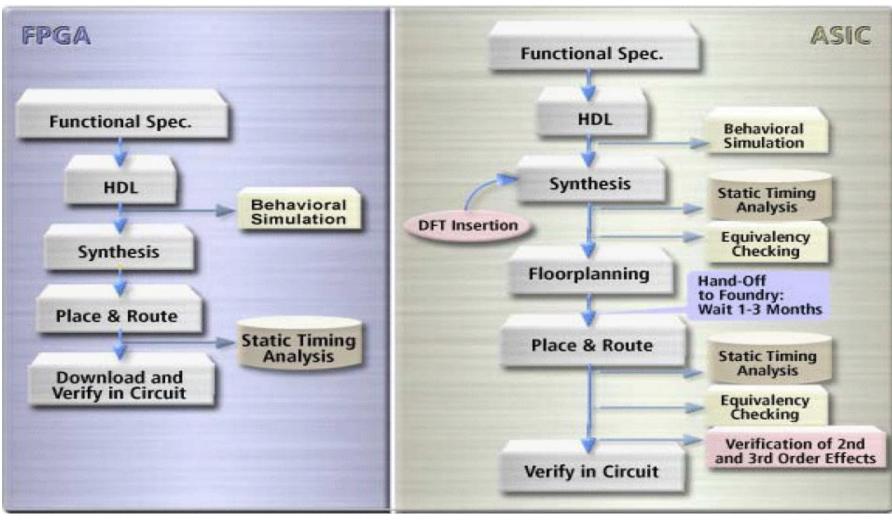






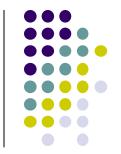
# FPGA & ASIC Design Flow Comparison







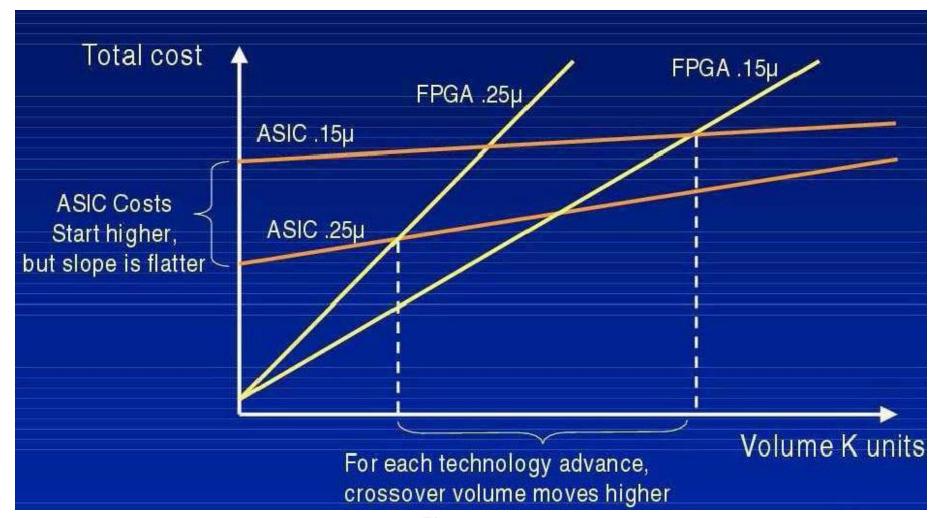
## **FPGA & ASIC Advantages**



FPGA Design Advantages	ASIC Design Advantages
Faster time-to-market - no layout, masks	Full custom capability - for design since
or other manufacturing steps are needed	device is manufactured to design specs
No upfront NRE (non recurring expenses) - costs typically associated with an ASIC design	Lower unit costs - for very high volume designs
Simpler design cycle - due to software that handles much of the routing, placement, and timing	Smaller form factor - since device is manufactured to design specs
More predictable project cycle - due to	
elimination of potential re-spins, wafer capacities, etc.	Higher raw internal clock speeds
Field reprogramability - a new bitstream	
can be uploaded remotely	
EMICON THINNING QUI OF THE ROX.	

#### **Unit Cost Analysis**

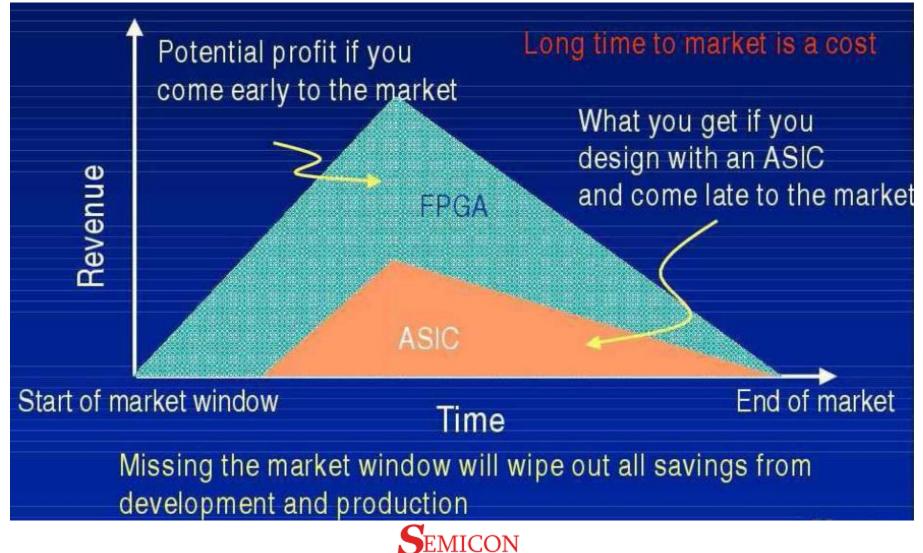






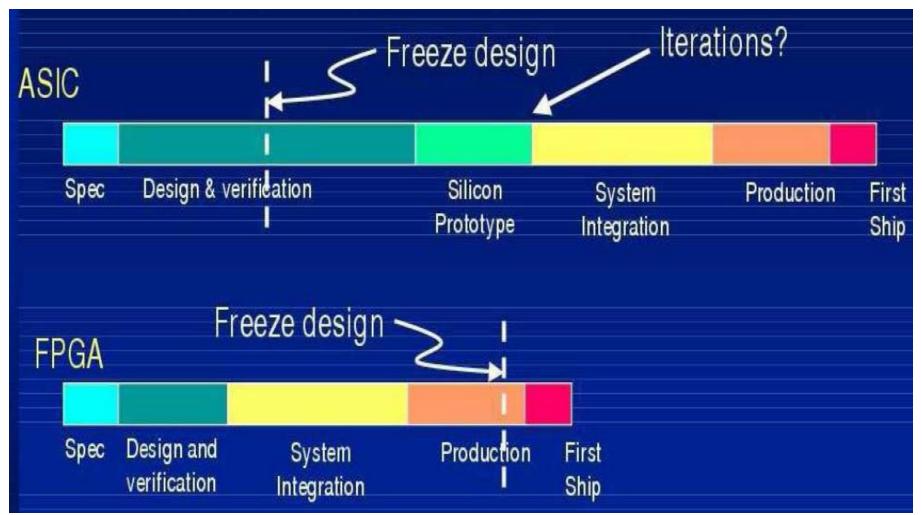
#### **Time to Market**





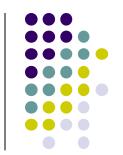
#### **Design Cycle**

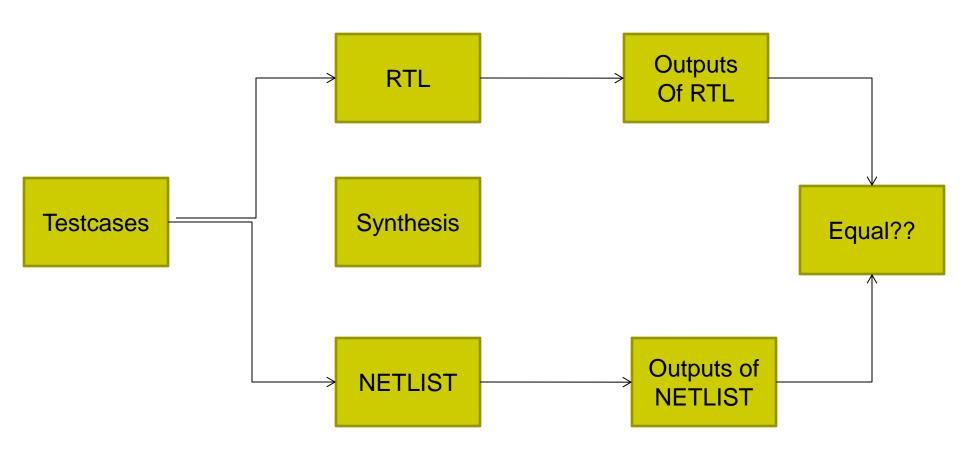






## **Equivalent Checking Idea**

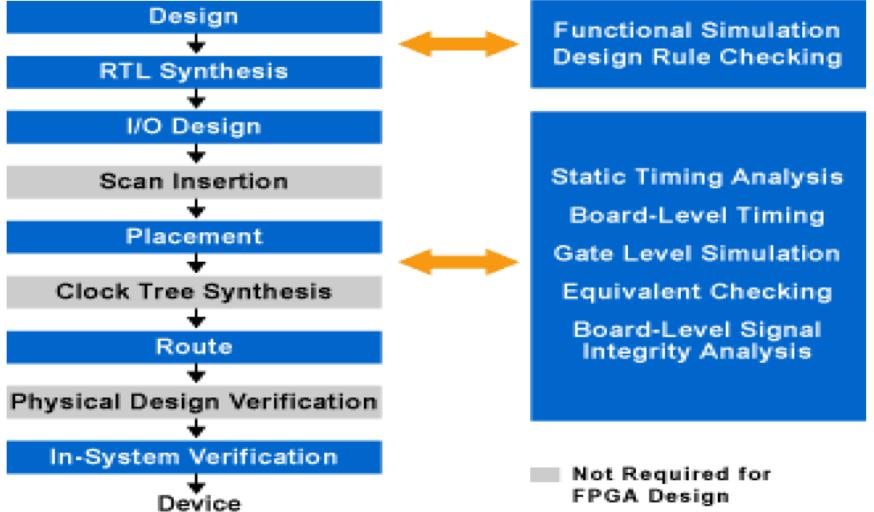




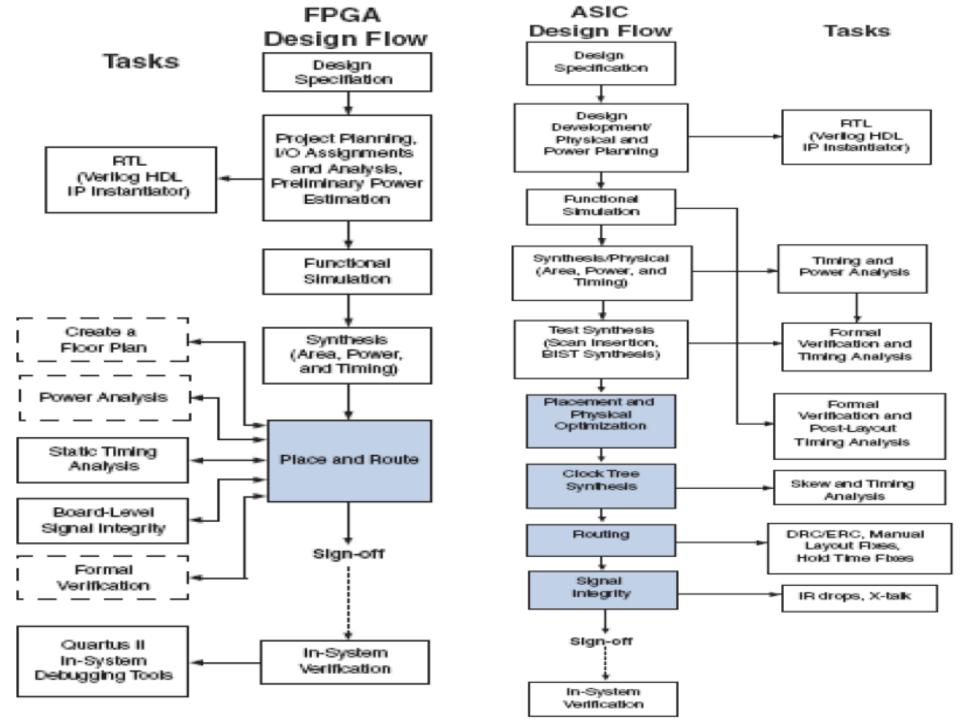


# FPGA and ASIC Design Flows Fundamentally Similar











#### **CMOS Logic**

(Complementary Metal-Oxide Semiconductor logic )



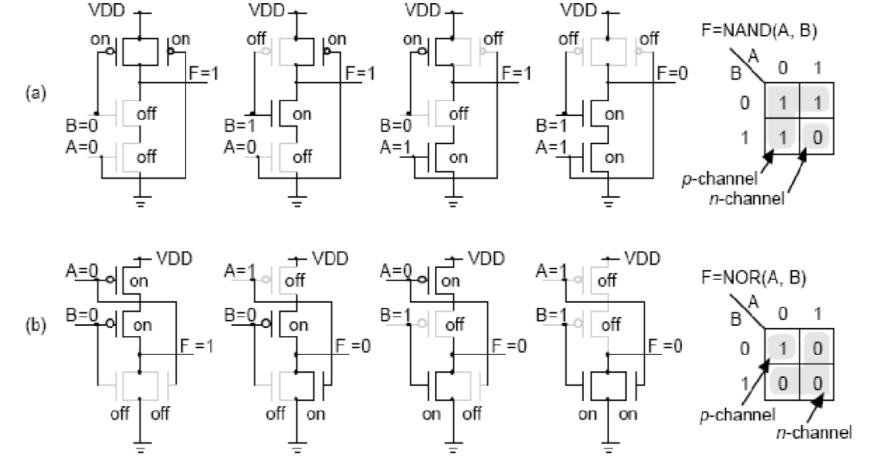
#### **Agenda**

- CMOS logic
- Logic levels
- Transmission Gates
- Sequential Logic Cells
- Datapath Logic Cells



## **CMOS** Logic



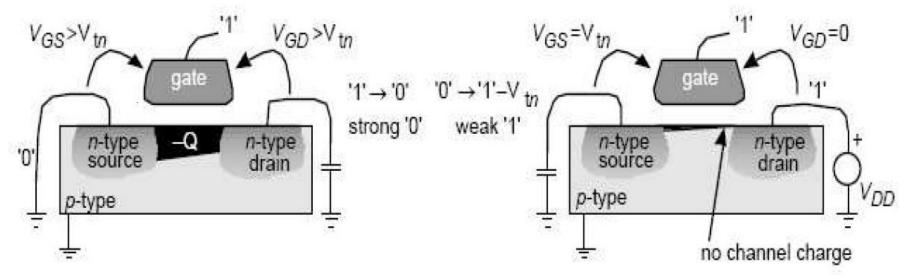


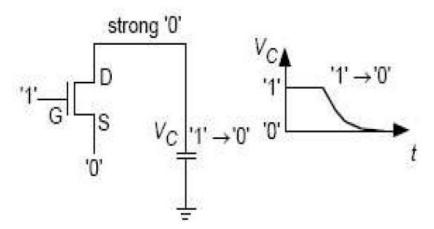
CMOS logic • a two-input NAND gate • a two-input NOR gate • Good '1's • Good '0's

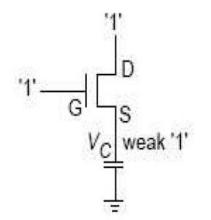


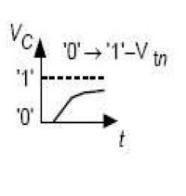
#### **Logic Levels**





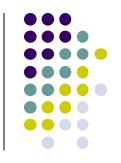


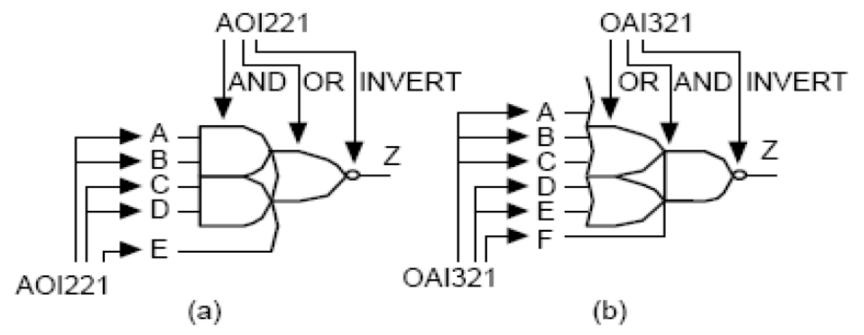






# Naming of complex CMOS combinational logic cells





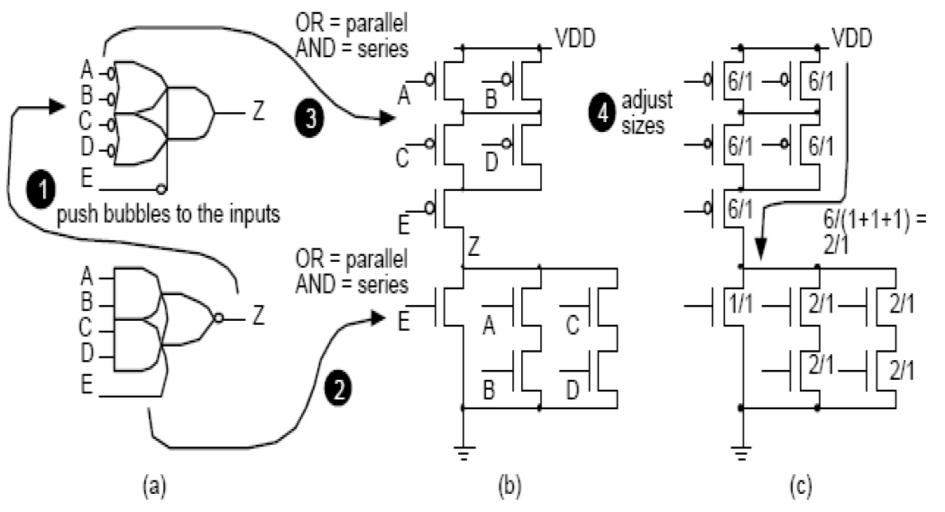
#### **Drive Strength**

We **ratio** a cell to adjust its **drive strength** and make bn=bp to create equal rise and fall times



# Naming of complex CMOS combinational logic cells



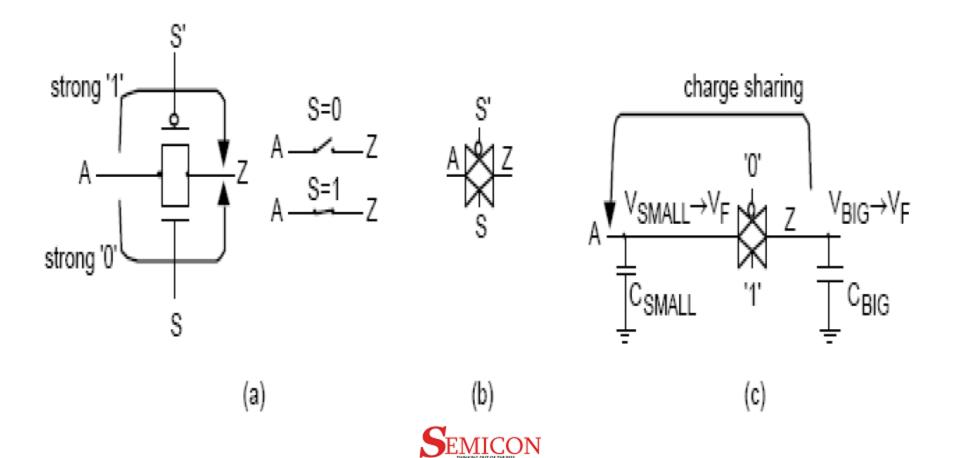




#### **Transmission Gates**

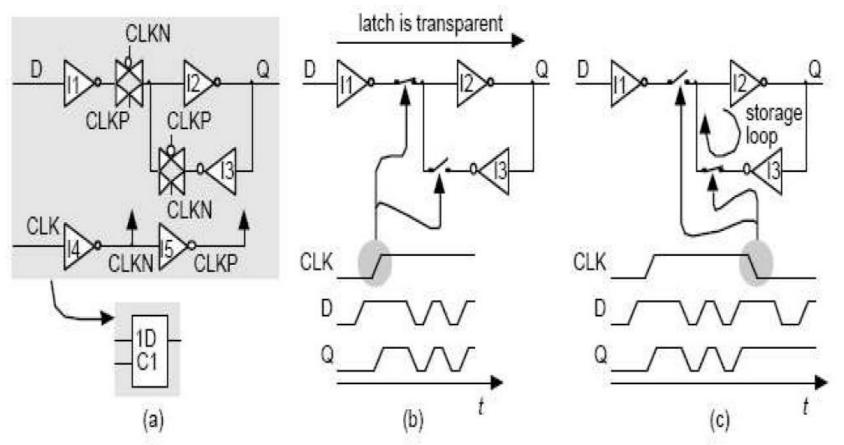


CMOS transmission gate (TG, TX gate, pass gate, coupler)



#### Sequential Logic Cells



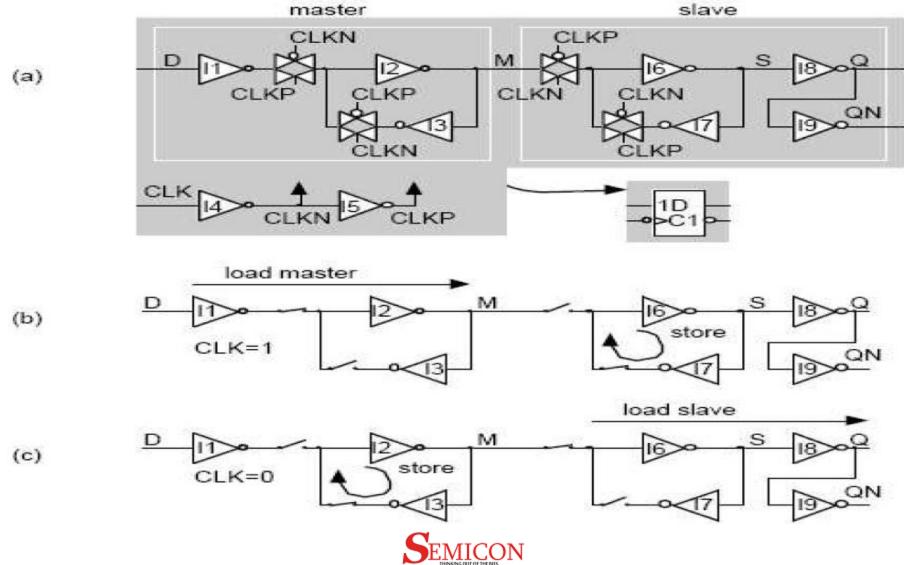


CMOS latch • enable • transparent • static • sequential logic cell • storage • initial value

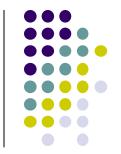


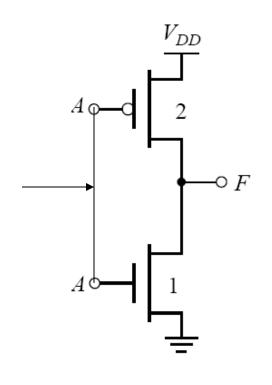
# CMOS flip-flop





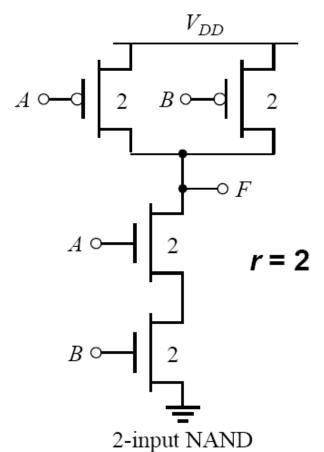
#### **Example of Basic Gates**

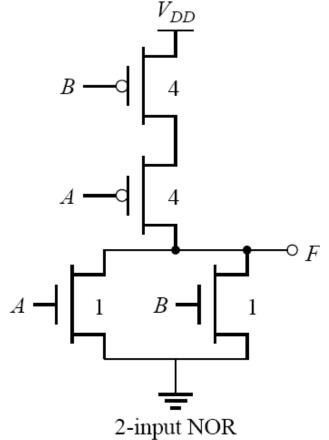












g = 5/3



# Specification Design



### Finish Design Documents

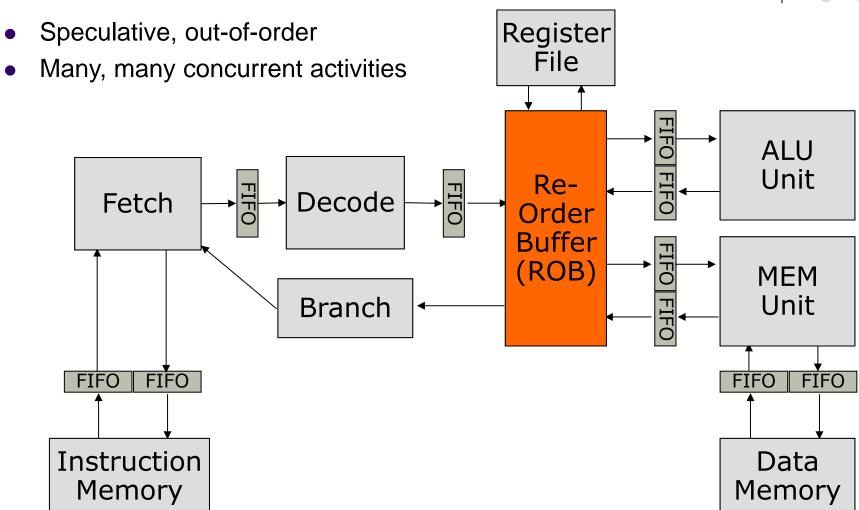


- Interface Specification
- Function Specification
- Design Details



#### Detail block is finished









# RTL Coding





# **Simulation**



#### **Agenda**

- Introduction
- How Logic Simulation Works
- Types of Simulation
  - Behavioral Simulation
  - Functional Simulation
    - Formal Verification
  - Static Timing Analysis
  - Gate-Level Simulation
  - Switch-Level Simulation
  - Transistor-Level Simulation



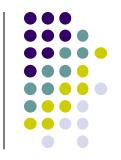
#### Introduction



- Simulation is used at many stages during ASIC design.
- Initial prelayout simulations include logic cell delays but no interconnect delays.
- Estimates of capacitance may be included after completing logic synthesis, but only after physical design it is possible to perform an accurate postlayout simulation.



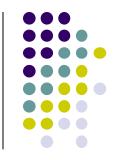
### **How Logic Simulation Works**



- The most common type of digital simulator is an eventdriven simulator.
- When a circuit node changes in value the time, the node, and the new value are collectively known as an event.
- The event is scheduled by putting it in an event queue or event list.
- When the specified time is reached, the logic value of the node is changed.
- The change affects logic cells that have this node as an input.
- All of the affected logic cells must be evaluated, which may add more events to the event list.



### **How Logic Simulation Works**



- The simulator keeps track of the current time, the current time step, and the event list that holds future events.
- For each circuit node the simulator keeps a record of the logic state and the strength of the source or sources driving the node.
- When a node changes logic state, whether as an input or as an output of a logic cell, this causes an event.
- An interpreted-code simulator uses the HDL model as data, compiling an executable model as part of the simulator structure, and then executes the model.
- This type of simulator usually has a short compile time but a longer execution time compared to other types of simulator.



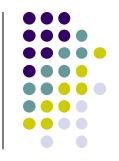
## **Types of Simulation**



- Simulators are usually divided into the following categories or simulation modes.
  - Behavioral simulation
  - Functional simulation
  - Static timing analysis
  - Gate-level simulation
  - Switch-level simulation
  - Transistor-level or circuit-level simulation



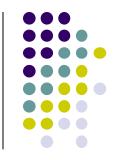
## **Types of Simulation**



- This list is ordered from high-level to low-level simulation (high-level being more abstract, and low-level being more detailed).
- Proceeding from high-level to low-level simulation, the simulations become more accurate, but they also become progressively more complex and take longer to run.
- While it is just possible to perform a behavioral-level simulation of a complete system, it is impossible to perform a circuit-level simulation of more than a few hundred transistors.
- There are several ways to create an imaginary simulation model of a system.



#### **Behavioral Simulation**



- The method which models large pieces of a system as black boxes with inputs and outputs.
- This type of simulation (often using VHDL or Verilog) is called behavioral simulation.
- Thus, behavioral simulation can only tell us if our design does work; it cannot tell us that real hardware will work.
- We use logic synthesis to produce a structural model from a behavioral model.





- To find the critical path using logic simulation requires simulating all possible input transitions and then shifting through the output to find the critical path.
- Vector-based simulation (or dynamic simulation) can show us that our design functions correctly hence the name functional simulation.
- Functional simulation ignores timing and includes unit-delay simulation, which sets delays to a fixed value (for example, 1 ns).
- However, functional simulation does not work well if we wish to find the critical path. Functional Simulation





- Once a behavioral or functional simulation predicts that a system works correctly, the next step is to check the timing performance.
- At this point a system is partitioned into smaller ASICs and a timing simulation is performed for each ASIC separately (otherwise the simulation run times become too long).
- One class of timing simulators employs timing analysis that analyzes logic in a static manner, computing the delay times for each path, this is called **static timing analysis** because it does not require the creation of a set of test (or stimulus) vectors (difficult for a large ASIC).
- Timing analysis works best with synchronous systems whose maximum operating frequency is determined by the longest path delay between successive flip-flops.





- The path with the longest delay is the critical path.
- Logic simulation or gate-level simulation can also be used to check the timing performance of an ASIC.
- In a gate-level simulator a logic gate or logic cell (NAND, NOR, and so on) is treated as a black box modeled by a function whose variables are the input signals.
- The function may also model the delay through the logic cell.
- Setting all the delays to unit value is the equivalent of functional simulation.
- Timing information for most gate-level simulators is calculated once, before simulation, using a delay calculator.
- This works as long as the logic cell delays and signal ramps do not change.





- In addition to pin-to-pin timing differences there is a timing difference depending on state.
- If the timing simulation provided by a black-box model of a logic gate is not accurate enough?
- The next, more detailed, level of simulation is switchlevel simulation which models transistors as switches on or off.
- Switch-level simulation can provide more accurate timing predictions than gate-level simulation, but without the ability to use logic-cell delays as parameters of the models.
- The most accurate, but also the most complex and timeconsuming, form of simulation is transistor-level simulation.
- A transistor-level simulator requires models of transistors, describing their nonlinear voltage and current characteristics.



#### **Formal Verification**



- Using logic synthesis we move from a behavioral model to a structural model.
- How are we to know (other than by trusting the logic synthesizer) that the two representations are the same?
- We have already seen that we may have to alter the original reference model because the HDL acceptable to a synthesis tool is a subset of HDL acceptable to simulators.
- Formal verification can prove, in the mathematical sense, that two representations are equivalent.
- If they are not, the software can tell us why and how two representations differ.



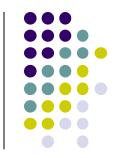
## **Static Timing Analysis**



- A timing analyzer answers the question: What is the longest delay in my circuit?
- The timing analyzer gives us only the critical path and its delay.
- A timing analyzer does not give us the input vectors that will activate the critical path.
- In fact input vectors may not exist to activate the critical path.
- The Paths which are impossible to activate, are known as false paths.
- Timing analysis is essential to ASIC design but has limitations.
- A timing-analysis tool is more logic calculator than logic simulator.



#### **Gate-Level Simulation**



- The simulator is adding capacitance to the outputs of each of the logic cells to model the parasitic net capacitance (interconnect capacitance or wire capacitance) that will be present in the physical layout.
- The model that predicts these values is known as a wireload model, wire-delay model, or interconnect model.
- Changing the wire-load model parameters to zero and repeating the simulation changes the critical-path delay, which agrees exactly with the logic-synthesizer timing analysis.
- This emphasizes that the net capacitance may contribute a significant delay.





## **Logic Synthesis**



## Why Synthesis?



- Increasing complexity of designs.
  - Multi-million gate designs
- Time to market.
- Multiple target technologies.
- Conflicting constrains.
- Correct by construction.



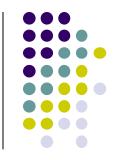
## **Logic Synthesis**



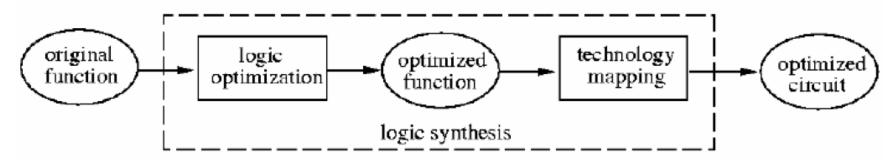
- Logic synthesis provides a link between an HDL and a netlist similarly to the way that a C compiler provides a link between C code and machine language.
- C was developed for use with compilers, but HDLs were not developed for use with logic-synthesis tools.
- Verilog was designed as a simulation language.
- VHDL was designed as a documentation and description language.
- Both Verilog and VHDL were developed in the early 1980s, well before the introduction of commercial logic synthesis software.



## **Logic Synthesis**

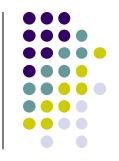


- Logic Synthesis optimize the implementation cost of Boolean logic.
- Cost:
  - area, delay, power.
- Optimization can be:
  - Technology independent optimization (logic optimization)
  - Technology dependent optimization (technology mapping)

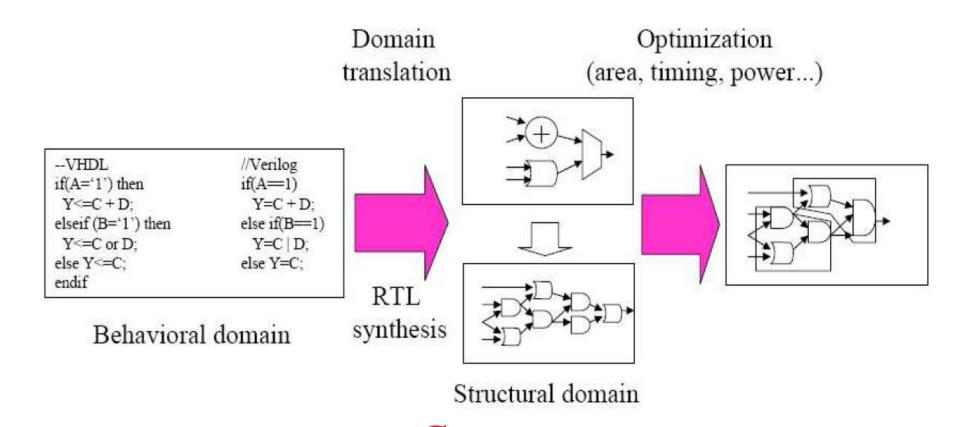




## **HDL Synthesis**

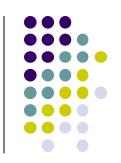


#### Synthesis = Domain Translation + Optimization



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## For example



$$f1 = abcd + abcd + abcd + abcd + abcd + abcde + abcde + abcdf$$
  
 $ac + cdf + abcde + abcdf$   
 $f2 = bdg + bdfg + bdg + bdeg$ 



$$f1 = c (\overline{a} + x) + \overline{acx}$$

$$f2 = gx$$

$$x = d (b + f) + \overline{d} (\overline{b} + e)$$



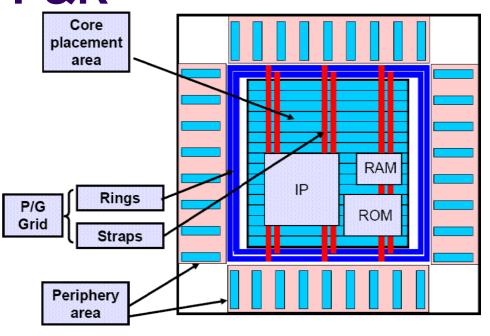


## Floorplanning



# Design Must Be Floorplanned Before P&R





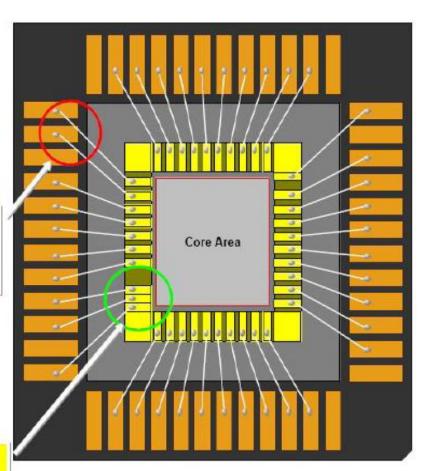
- Floorplan of design:
  - Core area defined with large macros placed
  - Periphery area defined with I/O macros placed
  - Power and Ground Grid (Rings and Straps) established
- Utilization:
  - The percentage of the core that is used by placed standard cellsand macros
  - Goal of 100%, typically 80-85%



# I/O Placement and Chip Package Requirements



Wire crossing over bond finger violation.



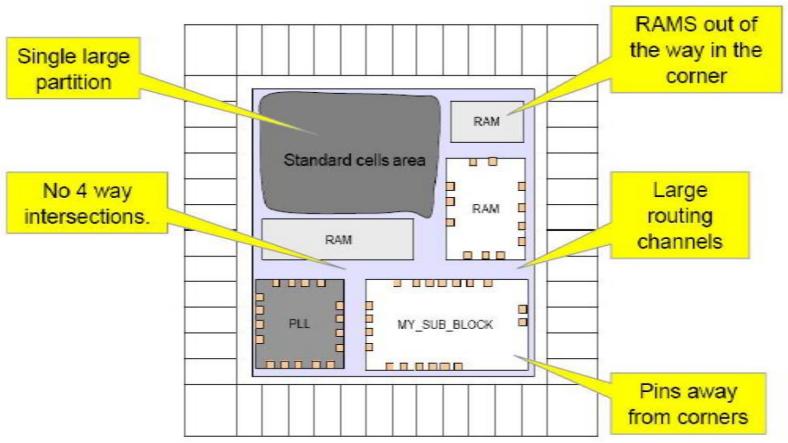
- Some Bond Wire requirements:
  - No Crossing
  - Minimum Spacing
  - Maximum Angle
  - Maximum Length

Pads can be moved to clear violation.



#### Guidelines for a Good Floorplan



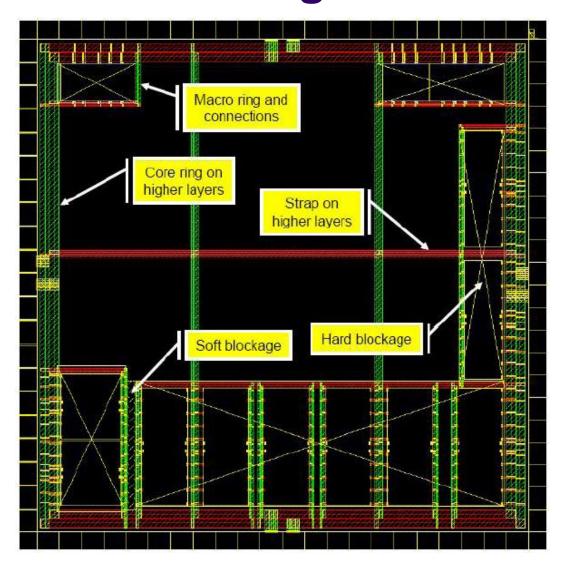


A few quick iterations of place and route with timing checks may reveal the need for a different floorplan



# Defining the Power/Ground Grid and Blockages





- Purpose of Grid is to take the VDD and VSS received from the I/O area and distribute it over the core area
- Blockages can also be added in the floorplan to prohibit standards cells from being placed in those areas

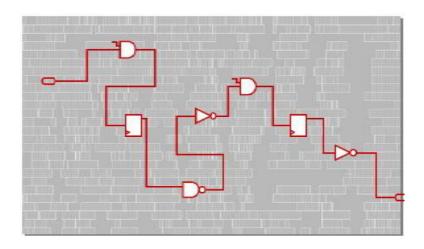




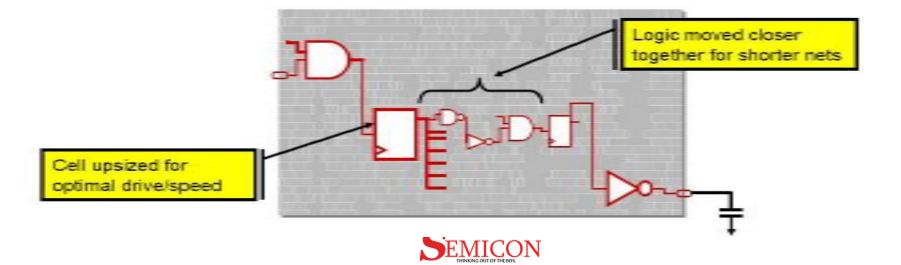
## **Placement**



#### **Timing Driven Placement**

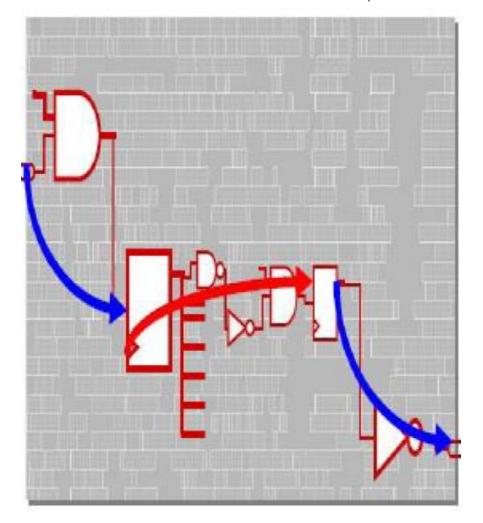


- Tools optimizes, places, and routes the logic gates to meet all timing constraints
- Balancing design requirements
  - Timing
  - Area
  - Power
  - Signal Integrity



#### **Timing Constraints**

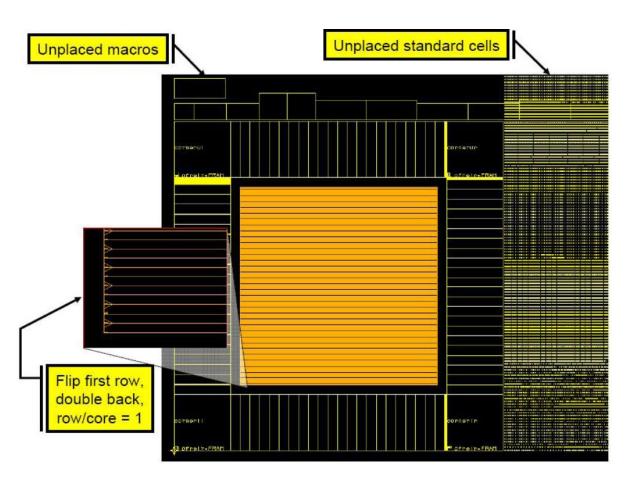
- Tool needs constraints to understand the timing intentions
  - Arrival time of inputs
  - Required arrival time at outputs
  - Clock period





#### **Timing Driven Placement**

- Timing Driven
   Placement places
   critical path cells
   close together to
   reduce net RC
- Prior to routing, RC are based on Virtual Routes
- What if critical paths do not meet timing constraints with placement?



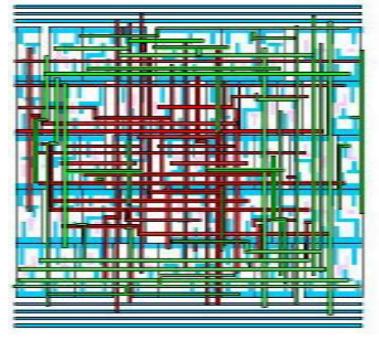




## Routing



#### Routing





— Critical Net

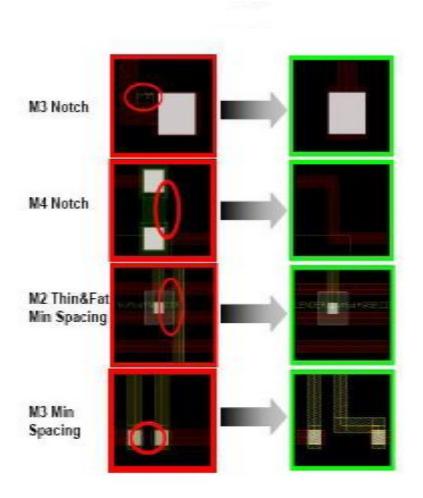
Non-Critical Net

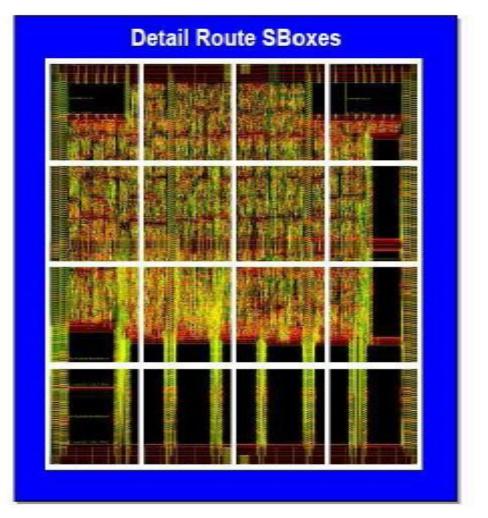
- Routing along the timing
  - critical path is given priority
  - Creates shorter, faster connections
- Non-critical paths are routed around critical areas
  - Reduces routing congestion problems for critical paths
  - Does not adversely impact timing of non-critical paths



## **Detailed Routing**









#### Conclusion

- Designing a sophisticated VLSI design is complicated
  - Number of transistors combined with challenges at each processing node
- Design time can be over 1 year from system conception to fabricated chips
- No one person or design team could manually design and complete a system in a time frame to be market competitive

Task of Designing, Placing,
Routing, and Fabricating Complex VLSI Designs
Must Become Automated





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